## **AMENDMENTS TO THE CLAIMS:**

1. (Currently Amended) A light emitting apparatus, comprising:

a semiconductor light emitting element that radiates light from [[its]] <u>a</u> light emission surface provided on <u>a side</u> [[the]] opposite <u>side to its to an</u> electrode forming surface <u>of said</u> light emitting element;

lead frames that are electrically connected to electrodes formed on the electrode forming surface through wires;

a transparent structure that is optically connected with the light emission surface and has a light distribution characteristic based on its three-dimensional shape, said transparent structure being mounted on a substrate positioned on a side opposite said light emitting element; and

light transmitting resin that seals the semiconductor light emitting element and the transparent structure.

- (Original) The light emitting apparatus according to claim 1, wherein:
   the transparent structure has a length in the horizontal direction greater than that of the semiconductor light emitting element.
- 3. (Original) The light emitting apparatus according to claim 1, wherein:

the transparent structure has a thickness of half that of the semiconductor light emitting element to twice the length of a shorter side of the semiconductor light emitting element.

HIR.089

- 4. (Original) The light emitting apparatus according to claim 1, wherein: the transparent structure has a microscopic uneven surface to diffuse light.
- 5. (Original) The light emitting apparatus according to claim 1, wherein: the transparent structure has a reflection layer formed on its surface.
- 6. (Original) The light emitting apparatus according to claim 1, wherein:

  one of the lead frames has a cup portion, and

  the transparent structure is fixed on the cup portion through adhesive resin with light diffusion material mixed therein.
- 7. (Original) The light emitting apparatus according to claim 1, wherein: the electrodes do not transmit light.
- 8. (Currently Amended) A light emitting apparatus, comprising:

a semiconductor light emitting element that radiates light from [[its]] <u>a</u> light emission surface provided on <u>a substrate</u> [[the]] opposite <u>side to its</u> <u>an</u> electrode forming surface;

lead frames that are electrically connected to electrodes formed on the electrode forming surface through wires;

a transparent structure that is optically connected with the light emission surface and has a light distribution characteristic based on its three-dimensional shape; and

light transmitting resin that seals the semiconductor light emitting element and the transparent structure, the light transmitting resin including a phosphor to wavelength-convert light emitted from the semiconductor light emitting element.

- 9. (Original) The light emitting apparatus according to claim 8, wherein: the light transmitting resin contains two or more kinds of phosphors.
- (New) The light emitting apparatus according to claim 1, wherein the semiconductor 10. light emitting element comprises the substrate, a buffer layer, an n-type semiconductor layer, a light-emitting layer, and a p-type semiconductor layer.
- (New) The light emitting apparatus according to claim 1, wherein the semiconductor 11. light emitting element comprises a gallium nitride system compound semiconductor.
- (New) The light emitting apparatus according to claim 1, wherein the transparent 12. structure comprises a light transmitting material comprising at least one of SiO<sub>2</sub>, Al<sub>2</sub>O<sub>3</sub>, SiC, Si<sub>3</sub>N<sub>4</sub>, AlN, ZrO<sub>2</sub>, borosilicate glass, and alumino-silicate glass.
- 13. (New) The light emitting apparatus according to claim 1, wherein the substrate comprises sapphire.

Serial No. 10/774,389 Docket No. PTGF-03083 HIR.089

- 14. (New) The light emitting apparatus according to claim 1, wherein the transparent structure is connected to the light emission surface by an adhesive layer.
- 15. (New) The light emitting apparatus according to claim 14, wherein the adhesive layer comprises a transparent adhesive.
- 16. (New) A light emitting apparatus, comprising:

a semiconductor light emitting element that radiates light from a light emission surface provided on an opposite side to an electrode forming surface of said light emitting element;

lead frames that are electrically connected to electrodes formed on the electrode forming surface through wires;

a transparent structure that is optically connected with the light emission surface and has a light distribution characteristic based on its three-dimensional shape; and

light transmitting resin that seals the semiconductor light emitting element and the transparent structure,

wherein the transparent structure has a length in the horizontal direction greater than that of the semiconductor light emitting element.